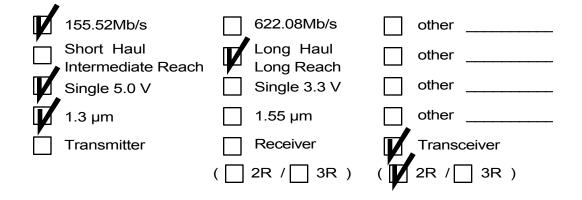




Technical Specification for **Optical Transceiver Module**

<u>SDM7111-XC</u> **SDM7111-GC**



SUMITOMO ELECTRIC

Sumitomo Electric reserves the right to make changes in this specification without prior notice.

#Safety Precaution Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

\land	Warning	Wrong operation without following this instruction may lead to human death or serious injury.
	Caution	Wrong operation without following this instruction may lead to human injury or property damage.

Exampleofpicturesymbols

indicates prohibition of actions. Action details are explained thereafter.

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indicates compulsory actions or instructions. Action details are explained thereafter. - $1\ /\ 9$ -

1. General

SDM7111-XC is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP DFB-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

* Data Rate * Duty Cycle * Power Supply Voltage * Electrical Interface * Fiber Coupled Power * Sensitivity * Connector Interface	10 ~ 155.52Mbps, NRZ 50% Single +5.0V PECL -5dBm for SMF ~ -34dBm SC Duplex Connector
The features of SDM7111-XC are	
	verConsumption
	file (9.8mm Max) Plastic Molded Package
	urcedFootprint
-	ncooled Laser with Automatic Power Control IC
CI	lass 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)
Receiver W	ide Dynamic Range
Si	gnal Detect (FLAG) Function

2. Block Diagram

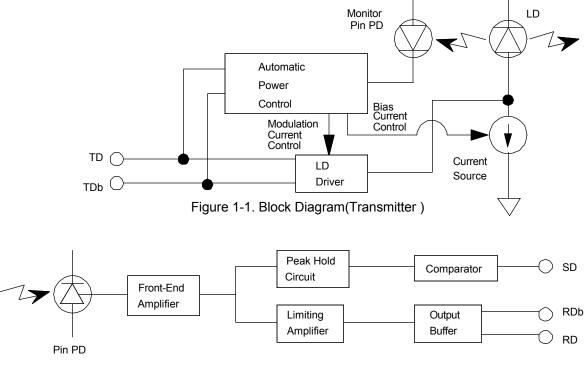


Figure 1-2. Block Diagram(Receiver)

3. Package Dimension

All dimensions are in mm.

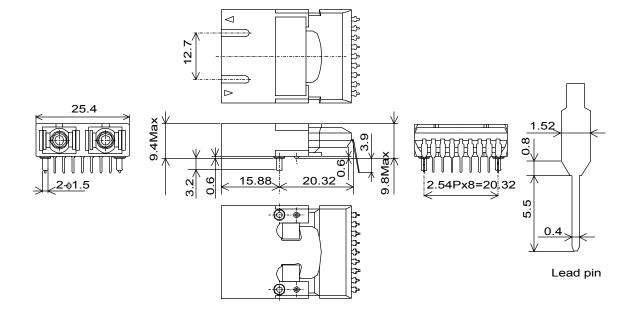


Figure 2-1. Outline Dimensions (SDM7111-XC)

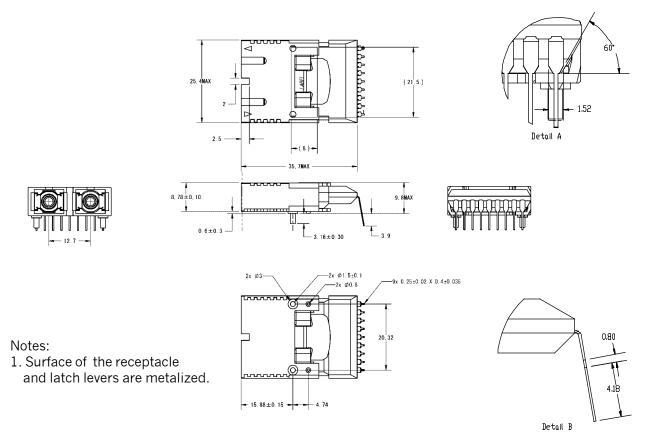


Figure 2-2. Outline Dimensions (SDM7111-GC-ZN)

All dimensions are in mm.

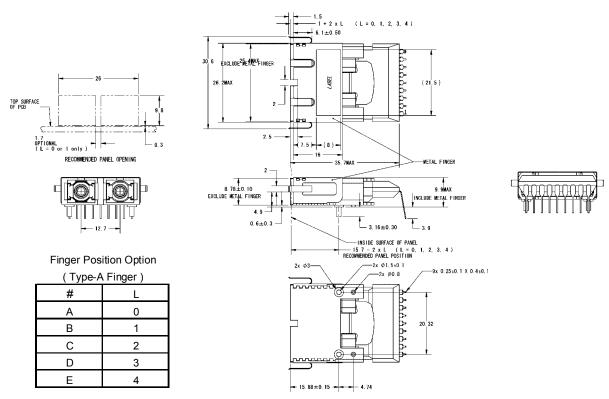


Figure2-3. Outline Dimensions (SDM7111-GC-#N)

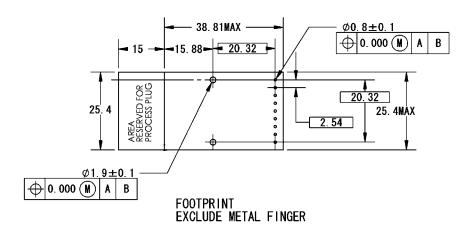


Figure2-4.RecommendedFootprint

∆ Caution
Do not disassemble this product. Otherwise, failure, electrical shock, overheating or fire may occur. Handle the lead pins carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

4. Pin Assignment

No.	Symbol	Function
1	Veerx	Power Supply (-) for Receiver : Connected to GND
2	RD	Differential Data Output (Positive)
3	RDb	Differential Data Output (Negative)
4	FLAG(SD)	FLAG (Signal Detect)
5	Vccrx	Power Supply (+) for Receiver : Connected to +5.0V
6	Vcctx	Power Supply (+) for Transmitter : Connected to +5.0V
7	TDb	Transmitter Differential Data (Negative)
8	TD	Transmitter Differential Data (Positive)
9	Veetx	Power Supply (-) for Transmitter : Connected to GND

5. Absolute Maximum Ratings

Parameter	Symbol	min.	Max	Unit	Note
Storage Case Temperature	Ts	-40	85	°C	1
Operating Case Teperature	Tc	0	70	°C	1
Supply Voltage	Vcc-Vee	0.0	6.0	V	2
Input Voltage (TD, TDb)	Vi	0.0	Vcc	V	
Output Voltage (RD, RDb, SD)	lo		30	mA	
Lead Soldering (Temperature)	Ltemp		260	°C	3
Lead Soldering (Time)	Ltime		10	sec.	3

Note 1. No condensation allowed. 2. Vcc>Vee, Vcc=+5.0V, Vee=GND 3. Measured on lead pin at 2mm (0.079in.) off the package bottom



6. Electrical Interface

(Unless otherwise specified, Vcc·Vee = 4.75 to 5.25 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter		Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	4.75	5.00	5.25	V	
Supply Current		ldtx		70	180	mA	1
Input Voltage	High	Vih	Vcc-1.17		Vcc-0.73	V	2
TD, TDb	Low	Vil	Vcc-1.95		Vcc-1.45		
Input Current	High	lih	-10		150	μA	2
TD, TDb	Low	lil	-10		10		
Signal Input Rise / Fall Time		Trin, Tfin			0.5	nsec.	3

Note 1. Input bias current is not included. 50% duty cycle data. 155.52Mbps 2. Vcc-Vee=5.0V, Tc=25°C 3. 20 ~ 80%

6-2. Receiver side

Param	Symbol	min.	Тур.	Max.	Unit	Note	
Supply Voltage		Vcc-Vee	4.75	5.00	5.25	V	
Supply Current		ldrx		60	110	mA	1
Data & SD	High	Voh	Vcc-1.03		Vcc-0.88	V	2
Output Voltage Low		Vol	Vcc-1.81		Vcc-1.62		
Data Rise / Fall Time of Output Signal		Trout, Tfout			1.6	nsec	3

Note 1. Output current is not included.

2. Vccrx=+5.0V, Tc=25°C, Output load resistance

3.20 ~ 80%

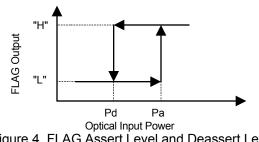


Figure 4. FLAG Assert Level and Deassert Level

7. Optical Interface

Unless otherwise specified, Vcc·Vee = 4.75 to 5.25 V and all operating temperature shall apply.) 7-1. Transmitter side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note	
Average Output Power to SMF	Pos	-5.0		0.0	dBm	1	
Extinction Ratio	Er	10.0			dB	1	
Center Wavelength	λς	1280		1335	nm		
Spectral Width (RMS)	Δλ			4.0	nm		
Eye Mask for Optical Output		Refer to Figure 5					

Note 1. Measured at 155.52Mbps PRBS2^23-1, 50% duty cycle data

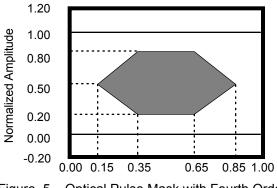


Figure 5. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

Relation between Input Signal and Optical Output Signal

Input	Signal	Optical Output Siganl			
TD TDb					
High	Low	ON (High)			
Low	High	OFF (Low)			
High	High	Undefined			
Low	Low	Undefined			



RI=50 Ω to Vccrx-2V for RD, RDb and SD.

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7-2. Receiver side

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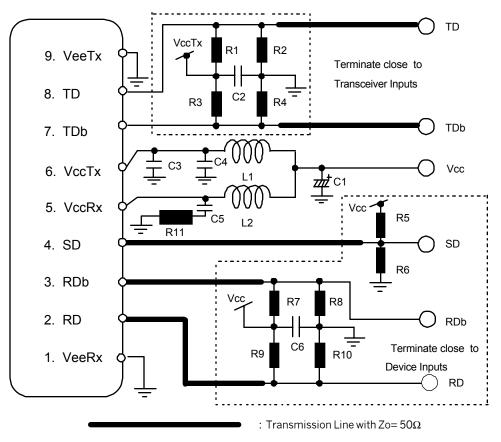
Symbolmin.Typ.Max.UnitNotePin-34.0-8.0dBm1, 2Par40.0-0.0-0.4-0.0

	e jinisei		. , p.	masa	•	
Average Input Power to SMF	Pin	-34.0		-8.0	dBm	1, 2
Flag Assert Level	Pa	-48.0	-36.0	-34.0	dBm	2
Flag deassert Level	Pd	-49.0	-39.0	-34.0	dBm	2
Flag Assert Time	Tsda			100	μsec	2, 3
Flag deassert Time	Tsdd			350	μsec	2, 3
Note 1 DED-100.10.2 Management at the hit rate	of 1EE EOMbra	DDDC 0400 4 N				

Note 1. BER=10^10, 2. Measured at the bit rate of 155.52Mbps, PRBS 2^23-1, NRZ 3. 50% duty cycle data

8. Recommended Inteface Circuit

Parameter



$$\label{eq:R1} \begin{split} R1 = R3 = R5 = R7 = R9 = 82\Omega \ , \ R2 = R4 = R6 = R8 = R10 = 130\Omega \ , \ R11 = 10\Omega \\ C1 = 100 \ \mu\text{F}, \ C3 = 2200 \ \text{pF}, \ C2 = C6 = 0.1 \ \mu\text{F}, \ C4 = C5 = 1 \ \mu\text{F} \\ L1, \ L2: \ \text{Ferrite Bead} \ \ ZBF \ 253D \ 00 \ (TDK) \end{split}$$

Figure 6 Recommended Interface Circuit

9. Reliability Test

Bellcore TA-NWT-000983 Issue 2, December 1993								
Heading	Test	Reference	Condition	Samplir	ng		SEI P	lan
				LTPD	SS	С	SS	F/C
Mechanica	Mechanical	MIL-STD-883	Condition B					
Integrity	Shock	Method 2002	5 times/axis					
			500G, 1.0 ms	20%	11	0		
			1,500G, 0.5ms	20%	11	0	11	0
	Vibration	MIL-STD-883	Condition A	20%	11	0	11	0
	Method 2007		20 G					
			20-2,000 Hz					
			4 min/cycle; 4 cycles/axis					
	Thermal Shock	MIL-STD-883	∆T=100°C	20%	11	0	11	0
		Method 1011						
	Solderability MIL-STD-883		(steam aging not required)	20%	11	0	11	0
		Method 2003						
	Fiber Pull		1 Kg; 3 times;5sec.	20%	11	0		
			2 Kg; 3 times; 5sec.	20%	11	0		
Endurance	Accel. Aging	(R)-453	+85C; rated power					
	(High Temp.)	Section 5.18	>5,000hrs.		25		25	0
			>10,000hrs.		10			
	High Temp.		max. storage T (T=85°C)	20%	11	0		
	Storage		>2,000					
	Low Temp.		min. storage T (T=-40°C)	20%	11	0	11	0
	Storage		>2,000					
	Temperature	Section 5.20	- 40°C to +85°C					
	Cycling		400 times pass/fail	20%	11	0		
			500 times for info.		11			
			500 times pass/fail	20%	11	0	11	0
			1000 times for info.		11		11	0
	Damp Heat		40°C , 95%, 56days	20%	11	0	11	0
	(if using epoxy)	or IEC 68-2-3	or 85°C /85%RH 2,000hrs.	20%	11	0		
	Cyclic Moisture	Section 5.23		20%	11	0	11	0
	Resistance							
Special	Internal	MIL-STD-883	< 5,000 ppm	20%	11	0	11	0
Tests	Moisture	Method 1018	water vapor					
	Flammability	TR357:Sec. 4.4.2.5						OK
	ESD Threshold	Section 5.22			6		6	0

10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 825-1.

Class 1 Laser Product

≜Caution

N lf this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classfication for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

	Δ Warning
	Besure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire. Do not put this product or components of this product into your mouth. This product contaions material harmful to health.
	▲ Caution
0	Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

12. Ordering Information

	Ordering Number	Connector type	Operating Temperature
	SCM7111-XC	SC Duplex Connector, Non-metallized.	
	SCM7111-GC-#N	SC Duplex Connector, Metallized. See chart below for detail.	-5 ~ 70°C

SDM7111-GC-# N

EMI Shield Finger Option Z : Without Finger

 $A \sim E$: With Type-A Finger

*Letter specifies finger position.

Refer to Figure2-3 for detail.

13. For More Information

U.S.A.

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